# MC74HC08A

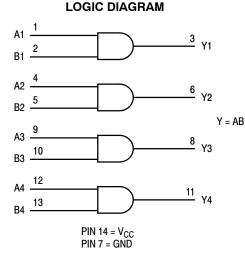
# **Quad 2-Input AND Gate**

## High-Performance Silicon-Gate CMOS

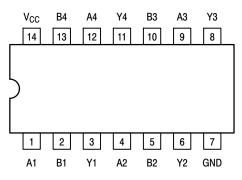
The MC74HC08A is identical in pinout to the LS08. The device inputs are compatible with Standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

### Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1 μA
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance With the JEDEC Standard No. 7A Requirements
- Chip Complexity: 24 FETs or 6 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free and are RoHS Compliant



### Pinout: 14-Lead Packages (Top View)

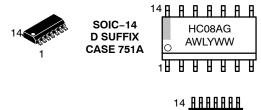




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### MARKING DIAGRAMS





А	= Assembly Location
L, WL	= Wafer Lot
Y, YY	= Year
W, WW	= Work Week
G or ∎	= Pb-Free Package

(Note: Microdot may be in either location)

### FUNCTION TABLE

Inp	uts	Output
Α	В	Y
L	L	L
L	н	L
н	L	L
н	н	н

### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

### MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GND)	– 0.5 to + 7.0	V
Vin	DC Input Voltage (Referenced to GND)	$-0.5$ to $V_{CC}$ + 0.5	V
Vout	DC Output Voltage (Referenced to GND)	$-0.5$ to $V_{CC}$ + 0.5	V
l <sub>in</sub>	DC Input Current, per Pin	± 20	mA
I <sub>out</sub>	DC Output Current, per Pin	± 25	mA
I <sub>CC</sub>	DC Supply Current, V <sub>CC</sub> and GND Pins	± 50	mA
PD	Power Dissipation in Still Air, SOIC Package† TSSOP Package†	500 450	mW
T <sub>stg</sub>	Storage Temperature	– 65 to + 150	°C
TL	Lead Temperature, 1 mm from Case for 10 Seconds SOIC or TSSOP Package	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range GND  $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

†Derating — SOIC Package: – 7 mW/°C from 65° to 125°C TSSOP Package: – 6.1 mW/°C from 65° to 125°C

### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Min	Max	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GND)		2.0	6.0	V
V <sub>in</sub> , V <sub>out</sub>	DC Input Voltage, Output Voltage (Referenced to GND)		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature, All Package Types		- 55	+ 125	°C
t <sub>r</sub> , t <sub>f</sub>	(Figure 1) V <sub>C</sub>	<sub>C</sub> = 2.0 V <sub>C</sub> = 4.5 V <sub>C</sub> = 6.0 V	0 0 0	1000 500 400	ns

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC74HC08ADG	SOIC-14 (Pb-Free)	55 Units / Rail
MC74HC08ADR2G	SOIC-14 (Pb-Free)	2500 / Tape & Reel
MC74HC08ADTR2G	TSSOP-14 (Pb-Free)	2500 / Tape & Reel
NLV74HC08ADG*	SOIC-14 (Pb-Free)	55 Units / Rail
NLV74HC08ADR2G*	SOIC-14 (Pb-Free)	2500 / Tape & Reel
NLV74HC08ADTR2G*	TSSOP-14 (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable

## MC74HC08A

### DC CHARACTERISTICS (Voltages Referenced to GND)

				Guara	nteed Lin	nit	
Symbol	mbol Parameter Condition		V <sub>CC</sub> V	–55 to 25°C	≤ <b>85°C</b>	≤125°C	Unit
V <sub>IH</sub>	Minimum High-Level Input Voltage	$\label{eq:Vout} \begin{split} V_{out} &= 0.1 V \text{ or } V_{CC} - 0.1 V \\  I_{out}  &\leq 20 \mu A \end{split}$		1.50 2.10 3.15 4.20	1.50 2.10 3.15 4.20	1.50 2.10 3.15 4.20	V
V <sub>IL</sub>	Maximum Low-Level Input Voltage	$\label{eq:Vout} \begin{split} V_{out} &= 0.1 V \text{ or } V_{CC} - 0.1 V \\  I_{out}  &\leq 20 \mu A \end{split}$	2.0 3.0 4.5 6.0	0.50 0.90 1.35 1.80	0.50 0.90 1.35 1.80	0.50 0.90 1.35 1.80	V
V <sub>OH</sub>	Minimum High-Level Output Voltage	$ \begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\  I_{out}  \leq 20 \mu A \end{array} $	2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V
		$ \begin{array}{l l} V_{in}=\!\!V_{IH} \text{ or } V_{IL} &  I_{out}  \leq 2.4 \text{m/} \\  I_{out}  \leq 4.0 \text{m/} \\  I_{out}  \leq 5.2 \text{m/} \end{array} $	4.5	2.48 3.98 5.48	2.34 3.84 5.34	2.20 3.70 5.20	
V <sub>OL</sub>	Maximum Low-Level Output Voltage	$ \begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ \left  I_{out} \right  \leq 20 \mu A \end{array} $	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V
		$\label{eq:Vin} \begin{array}{ll} V_{in} = V_{IH} \text{ or } V_{IL} & \begin{array}{l}  I_{out}  \leq 2.4 \text{mA} \\  I_{out}  \leq 4.0 \text{mA} \\  I_{out}  \leq 5.2 \text{mA} \end{array}$	4.5	0.26 0.26 0.26	0.33 0.33 0.33	0.40 0.40 0.40	
l <sub>in</sub>	Maximum Input Leakage Current	V <sub>in</sub> = V <sub>CC</sub> or GND		±0.1	±1.0	±1.0	μΑ
I <sub>CC</sub>	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0\mu A$	6.0	1.0	10	40	μA

## AC CHARACTERISTICS (C\_L = 50pF, Input $t_r$ = $t_f$ = 6ns)

	Vee	Guaranteed Limit		Guaranteed Limit		
Parameter	V	–55 to 25°C	≤ <b>85°C</b>	≤125°C	Unit	
Maximum Propagation Delay, Input A or B to Output Y (Figures 1 and 2)	2.0 3.0 4.5 6.0	75 30 15 13	95 40 19 16	110 55 22 19	ns	
Maximum Output Transition Time, Any Output (Figures 1 and 2)	2.0 3.0 4.5 6.0	75 27 15 13	95 32 19 16	110 36 22 19	ns	
Maximum Input Capacitance		10	10	10	pF	
Dever Dissigning Consistence (Der Ruffer)*	Typical @ 25°C, V <sub>CC</sub> = 5.0 V, V <sub>EE</sub> = 0 V		pF			
	Maximum Propagation Delay, Input A or B to Output Y (Figures 1 and 2) Maximum Output Transition Time, Any Output (Figures 1 and 2)	Maximum Propagation Delay, Input A or B to Output Y 2.0   (Figures 1 and 2) 3.0   Maximum Output Transition Time, Any Output 2.0   (Figures 1 and 2) 3.0   Maximum Input Capacitance 4.5   Typica	Parameter   V <sub>CC</sub> -55 to 25°C     Maximum Propagation Delay, Input A or B to Output Y   2.0   75     (Figures 1 and 2)   3.0   30     Maximum Output Transition Time, Any Output   2.0   75     (Figures 1 and 2)   2.0   75     Maximum Output Transition Time, Any Output   2.0   75     (Figures 1 and 2)   3.0   27     4.5   15   6.0   13     Maximum Input Capacitance   10   10	Parameter   V <sub>CC</sub> V   -55 to 25°C $\leq$ 85°C     Maximum Propagation Delay, Input A or B to Output Y (Figures 1 and 2)   2.0   75   95     3.0   3.0   40   4.5   115   19     6.0   13   16   16   16     Maximum Output Transition Time, Any Output (Figures 1 and 2)   2.0   75   95     Maximum Input Capacitance   2.0   75   19     Maximum Input Capacitance   10   10	Parameter   V <sub>C</sub> -55 to 25°C   ≤85°C   ≤125°C     Maximum Propagation Delay, Input A or B to Output Y (Figures 1 and 2)   2.0   75   95   110     3.0   3.0   4.0   55     4.5   15   19   22     6.0   13   16   19     Maximum Output Transition Time, Any Output (Figures 1 and 2)   2.0   75   95   110     Maximum Output Transition Time, Any Output (Figures 1 and 2)   2.0   75   95   110     Maximum Input Capacitance   10   10   19   22     6.0   13   16   19     Maximum Input Capacitance   10   10   10	

\* Used to determine the no–load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ .

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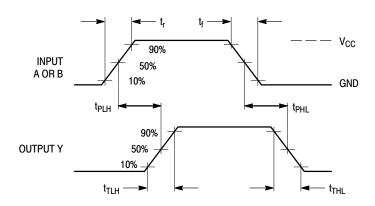
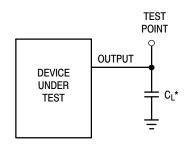


Figure 1. Switching Waveforms



\*Includes all probe and jig capacitance

Figure 2. Test Circuit



Figure 3. Expanded Logic Diagram (1/4 of the Device)





\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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